Unit: mm



TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

# SSM3J15FV

## **High-Speed Switching Applications Analog Switch Applications**

Optimum for high-density mounting in small packages

Low on-resistance : RDS(ON) = 12  $\Omega$  (max) (@VGS = -4 V)

: RDS(ON) = 32  $\Omega$  (max) (@VGS = -2.5 V)

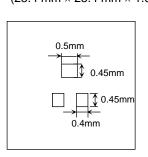
## **Absolute Maximum Ratings (Ta = 25°C)**

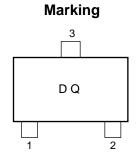
Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DSS</sub>	-30	V	
Gate-Source voltage		VGSS	±20	V	
Drain current	DC	ID	-100	mA	
	Pulse	IDP	-200		
Power dissipation (Ta = 25°C)		P <sub>D</sub> (Note 1)	150	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	−55 to 150	°C	

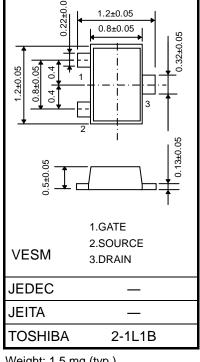
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board  $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 0.585 \text{ mm}^2)$ 

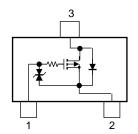






Weight: 1.5 mg (typ.)

#### **Equivalent Circuit (top view)**



#### **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

> Start of commercial production 2003-04

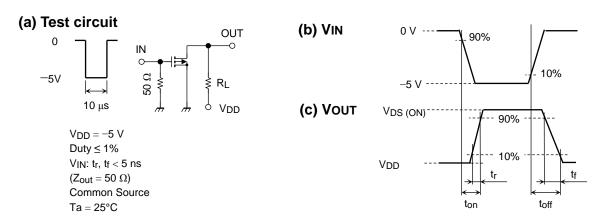


## **Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	MIN	TYP.	MAX	UNIT	
Gate leakage current		IGSS	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА	
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V	
Drain cut-off current		IDSS	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	_	_	-1	μА	
Gate threshold voltage	)	V <sub>th</sub>	$V_{DS} = -3 \text{ V}, I_{D} = -0.1 \text{ mA}$	-1.1	_	-1.7	V	
Forward transfer admit	ttance	Y <sub>fs</sub>	$V_{DS} = -3 \text{ V}, I_{D} = -10 \text{ mA (Note 2)}$	20	_	_	mS	
Drain-Source on-resistance		R <sub>DS</sub> (ON)	$I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V (Note 2)}$	_	8	12	Ω	
			I <sub>D</sub> = -1 mA, V <sub>GS</sub> = -2.5 V (Note 2)	_	14	32		
Input capacitance		C <sub>iss</sub>		_	9.1	_	pF	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -3 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	3.5	_	pF	
Output capacitance		Coss		_	8.6	_	pF	
Switching time	Turn-on time	ton	$V_{DD} = -5 \text{ V}, I_{D} = -10 \text{ mA},$	_	65	_	ns	
	Turn-off time	toff	VGS = 0 to −5 V	_	175	_		

Note 2: Pulse Test

#### **Switching Time Test Circuit**



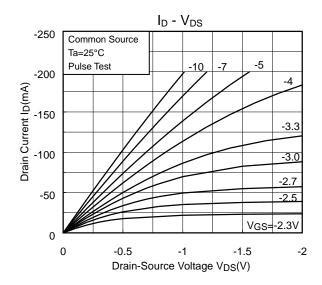
#### **Precaution**

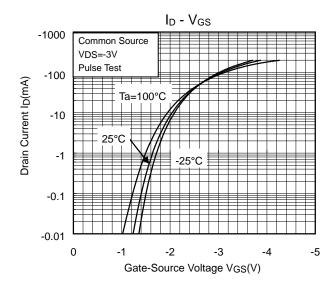
 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$  = -100  $\mu$ A for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ .

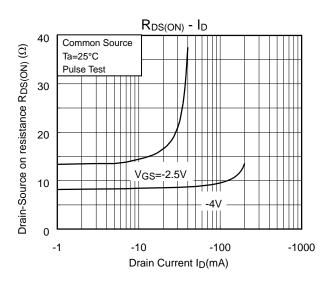
(The relationship can be established as follows: VGS (off) <  $V_{th}$  <  $V_{GS}$  (on) )

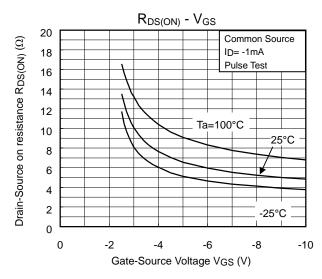
Please take this into consideration when using the device.

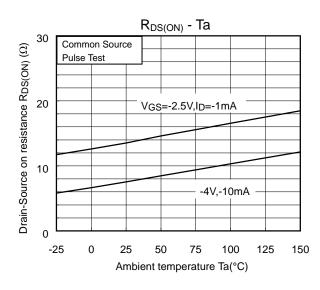


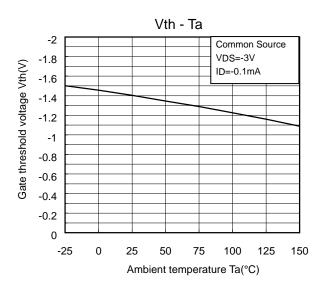




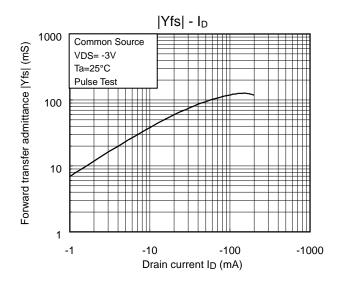


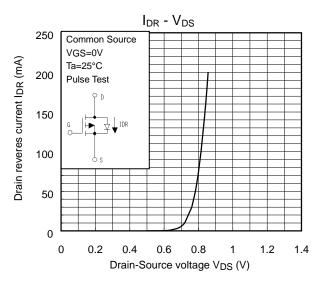


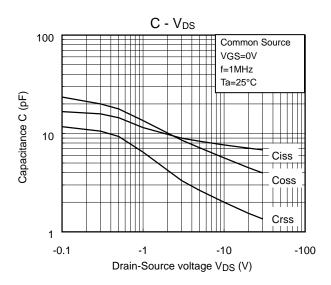


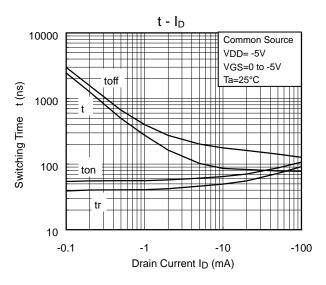


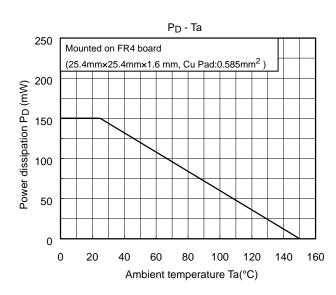














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